- **50-mA Low-Dropout Regulator**
- **Fixed Output Voltage Options: 5 V, 3.8 V, 3.3 V, 3.2 V, and 3 V**
- **Dropout Typically 120 mV at 50 mA**
- **Thermal Protection**
- **Less Than 1-μA Quiescent Current in Shutdown**
- **–40°C to 125°C Operating Junction Temperature Range**
- **5-Pin SOT-23 Package**
- **ESD Protection Verified to 1.5 kV Human Body Model (HBM) per MIL-STD-883C**

DBV PACKAGE
(TOP VIEW)

EN	GND	IN
3	2	1
4		5
NC		OUT

NC – No internal connection
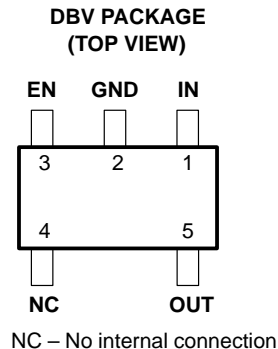
description

The TPS760xx is a 50 mA, low dropout (LDO) voltage regulator designed specifically for battery-powered applications. A proprietary BiCMOS fabrication process allows the TPS760xx to provide outstanding performance in all specifications critical to battery-powered operation.

The TPS760xx is available in a space-saving SOT–23 package and operates over a junction temperature range of –40°C to 125°C.

AVAILABLE OPTIONS

T_J	VOLTAGE	PACKAGE	PART NUMBER	SYMBOL
	3 V		TPS76030DBVR	PAGI
	3.2 V		TPS76032DBVR	PAOI
–40°C to 125°C	3.3 V	SOT-23	TPS76033DBVR	PAHI
	3.8 V		TPS76038DBVR	PAJI
	5 V		TPS76050DBVR	PANI

NOTE: The DBV package is available taped and reeled only.

functional block diagram

† Current sense

![caution symbol] Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.
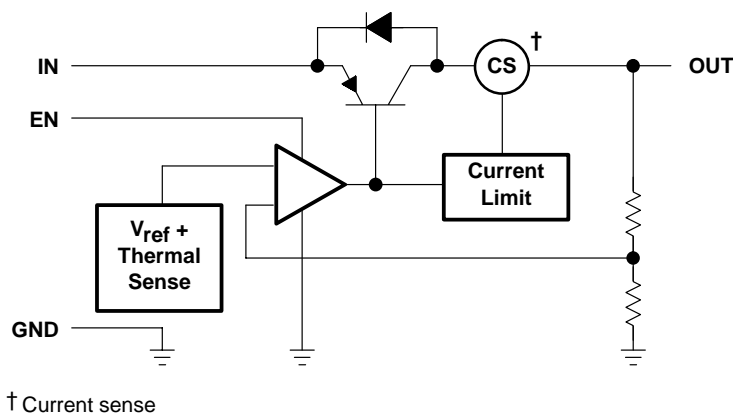
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TEXAS INSTRUMENTS

TPS76030, TPS76032, TPS76033, TPS76038, TPS76050
LOW-POWER 50-mA LOW-DROPOUT LINEAR REGULATORS

Terminal Functions

TERMINAL NAME	NO.	I/O	DESCRIPTION
EN	3	I	Enable input
GND	2		Ground
IN	1	I	Input voltage
NC	4		No connection
OUT	5	O	Regulated output voltage

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Input voltage range, V_I‡ . . . . –0.3 V to 16 V
Voltage range at EN . . . . –0.3 V to V_I + 0.3 V
Peak output current . . . . internally limited
Continuous total dissipation . . . . See Dissipation Rating Table
Operating junction temperature range, T_J . . . . –40°C to 150°C
Storage temperature range, T_{stg} . . . . –65°C to 150°C
ESD rating, HBM . . . . 1.5 kV

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
‡ All voltages are with respect to device GND pin.

DISSIPATION RATING TABLE

BOARD	PACKAGE	$R_{\theta JC}$	$R_{\theta JA}$	DERATING FACTOR ABOVE T_A = 25°C	$T_A \leq 25°C$ POWER RATING	T_A = 70°C POWER RATING	T_A = 85°C POWER RATING
Low K§	DBV	65.8 °C/W	259 °C/W	3.9 mW/°C	386 mW	212 mW	154 mW
High K¶	DBV	65.8 °C/W	180 °C/W	5.6 mW/°C	555 mW	305 mW	222 mW

§ The JEDEC Low K (1s) board design used to derive this data was a 3 inch x 3 inch, two layer board with 2 ounce copper traces on top of the board.
¶ The JEDEC High K (2s2p) board design used to derive this data was a 3 inch x 3 inch, multilayer board with 1 ounce internal power and ground planes and 2 ounce copper traces on top and bottom of the board.

recommended operating conditions

		MIN	NOM	MAX	UNIT
Input voltage, V_I	TPS76030	3.2		16	V
	TPS76032	3.4		16	
	TPS76033	3.5		16	
	TPS76038	4		16	
	TPS76050	5.2		16	
Continuous output current, I_O		0		50	mA
Operating junction temperature, T_J		–40		125	°C

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electrical characteristics over recommended operating free-air temperature range,
$V_I = V_{O(nom)} + 1$ V, $I_O = 1$ mA, EN = V_I, $C_O = 2.2$ μF (unless otherwise noted)

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_O	Output voltage	TPS76030	$T_J = 25°C$	2.96	3	3.04	V
			$T_J = 25°C$, $\quad$ 1 mA < I_O < 50 mA	2.92		3.04	
			1 mA < I_O < 50 mA	2.91		3.07	
		TPS76032	$T_J = 25°C$	3.16	3.2	3.24	V
			$T_J = 25°C$, $\quad$ 1 mA < I_O < 50 mA	3.13		3.24	
			1 mA < I_O < 50 mA	3.1		3.3	
		TPS76033	$T_J = 25°C$	3.26	3.3	3.34	V
			$T_J = 25°C$, $\quad$ 1 mA < I_O < 50 mA	3.23		3.34	
			1 mA < I_O < 50 mA	3.2		3.4	
		TPS76038	$T_J = 25°C$	3.76	3.8	3.84	V
			$T_J = 25°C$, $\quad$ 1 mA < I_O < 50 mA	3.73		3.84	
			1 mA < I_O < 50 mA	3.7		3.9	
		TPS76050	$T_J = 25°C$	4.95	5	5.05	V
			$T_J = 25°C$, $\quad$ 1 mA < I_O < 50 mA	4.91		5.05	
			1 mA < I_O < 50 mA	4.89		5.1	
$I_{I(standby)}$	Standby current		EN = 0 V			1	μA
	Quiescent current (GND current)		$I_O = 0$ mA, $\quad$ $T_J = 25°C$		90	115	μA
			$I_O = 0$ mA			130	
			$I_O = 1$ mA, $\quad$ $T_J = 25°C$		100	130	
			$I_O = 1$ mA			170	
			$I_O = 10$ mA, $\quad$ $T_J = 25°C$		190	215	
			$I_O = 10$ mA			260	
			$I_O = 50$ mA, $\quad$ $T_J = 25°C$		850	1100	
			$I_O = 50$ mA			1200	
	Input regulation	TPS76030	4 V < V_I < 16, $\quad$ $I_O = 1$ mA		3	10	mV
		TPS76032	4.2 V < V_I < 16, $\quad$ $I_O = 1$ mA		3	10	
		TPS76033	4.3 V < V_I < 16, $\quad$ $I_O = 1$ mA		3	10	
		TPS76038	4.8 V < V_I < 16, $\quad$ $I_O = 1$ mA		3	10	
		TPS76050	6 V < V_I < 16, $\quad$ $I_O = 1$ mA		3	10	
V_n	Output noise voltage		BW = 300 Hz to 50 kHz, $\quad$ $C_O = 10$ μF, $\quad$ $T_J = 25°C$		190		μVrms
	Ripple rejection		f = 1 kHz, $\quad$ $C_O = 10$ μF, $\quad$ $T_J = 25°C$		63		dB
	Dropout voltage		$I_O = 0$ mA $T_J = 25°C$		1	3	mV
			$I_O = 0$ mA			5	
			$I_O = 1$ mA, $\quad$ $T_J = 25°C$		7	10	
			$I_O = 1$ mA			15	
			$I_O = 10$ mA, $\quad$ $T_J = 25°C$		40	60	
			$I_O = 10$ mA			90	
			$I_O = 50$ mA $\quad$ $T_J = 25°C$		120	150	
			$I_O = 50$ mA			180	
	Peak output current/current limit			100	125	135	mA
	High level enable input			2			V
	Low level enable input					0.8	V
I_I	Input current (EN)		EN = 0 V	−1	0	1	μA
			EN = V_I		2.5	5	μA

![Texas Instruments logo]
TEXAS INSTRUMENTS

Table of Graphs

			FIGURE
V_O	Output voltage	vs Output current	1, 2, 3
		vs Free-air temperature	4, 5, 6
	Ground current	vs Free-air temperature	7, 8, 9
	Output noise	vs Frequency	10
Z_O	Output impedance	vs Frequency	11
V_{DO}	Dropout voltage	vs Free-air temperature	12
	Line transient response		13, 15
	Load transient response		14, 16

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TYPICAL CHARACTERISTICS

TPS76030
OUTPUT VOLTAGE
vs
OUTPUT CURRENT

$V_I = 4$ V
$T_A = 25°C$
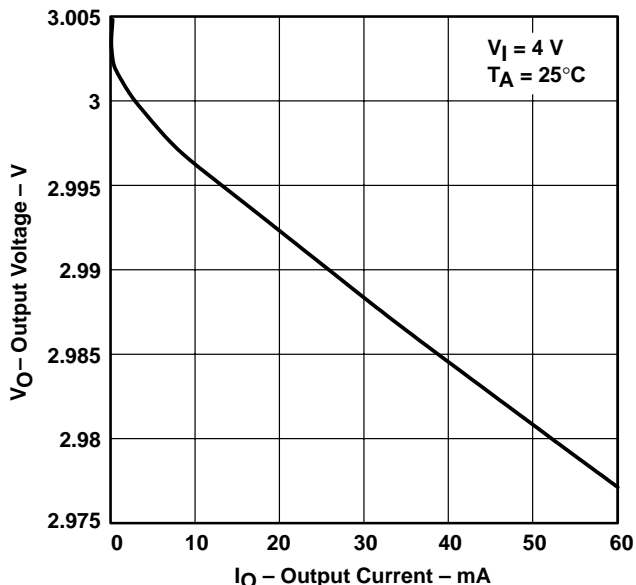
Figure 1

TPS76033
OUTPUT VOLTAGE
vs
OUTPUT CURRENT

$V_I = 4.3$ V
$T_A = 25°C$
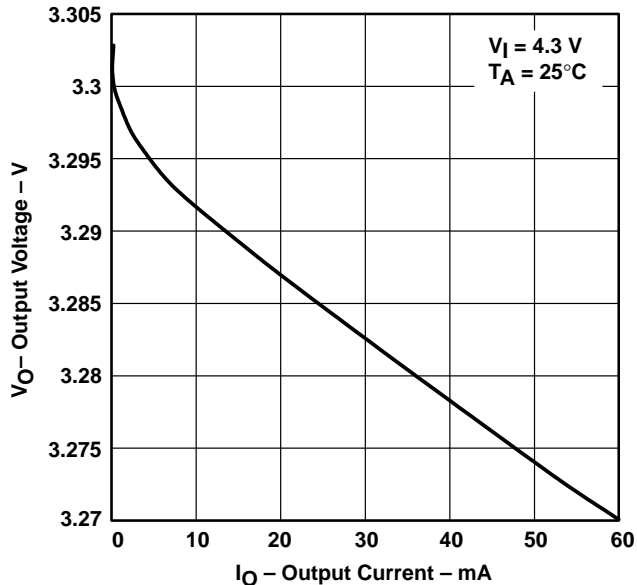
Figure 2

TPS76050
OUTPUT VOLTAGE
vs
OUTPUT CURRENT

$V_I = 6$ V
$T_A = 25°C$
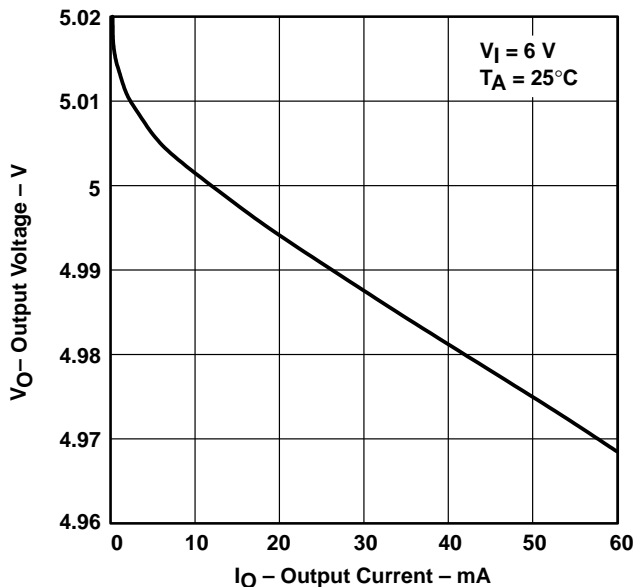
Figure 3

TPS76030
OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE
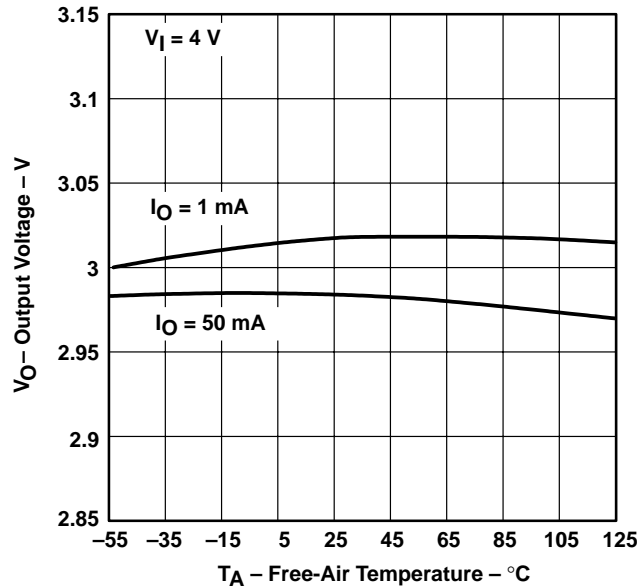
$V_I = 4$ V

$I_O = 1$ mA

$I_O = 50$ mA

Figure 4

![Texas Instruments logo]

TEXAS
INSTRUMENTS

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5

TPS76030, TPS76032, TPS76033, TPS76038, TPS76050
LOW-POWER 50-mA LOW-DROPOUT LINEAR REGULATORS

TYPICAL CHARACTERISTICS

TPS76033
OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE
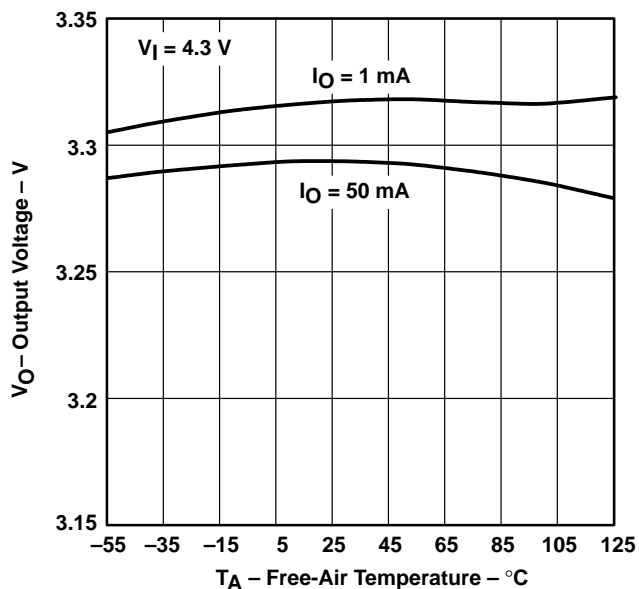
Figure 5

TPS76050
OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE
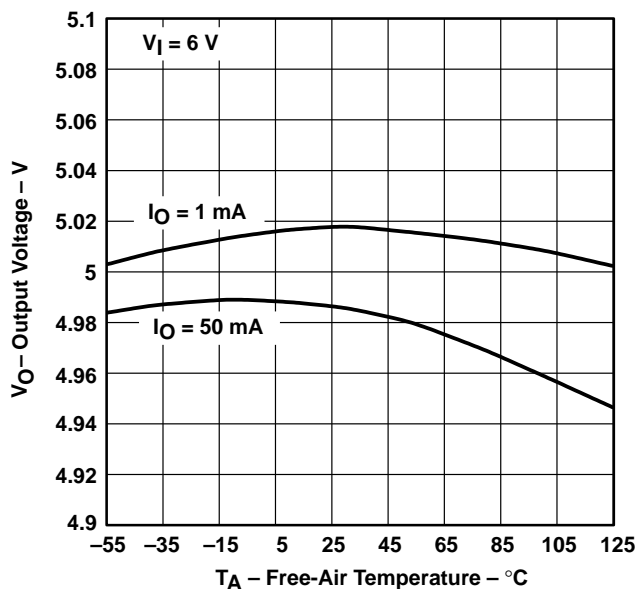
Figure 6

TPS76030
GROUND CURRENT
vs
FREE-AIR TEMPERATURE
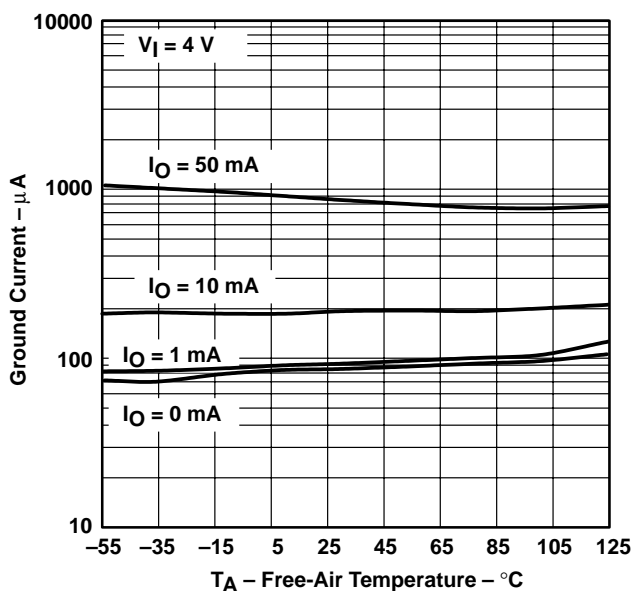
Figure 7

TPS76033
GROUND CURRENT
vs
FREE-AIR TEMPERATURE
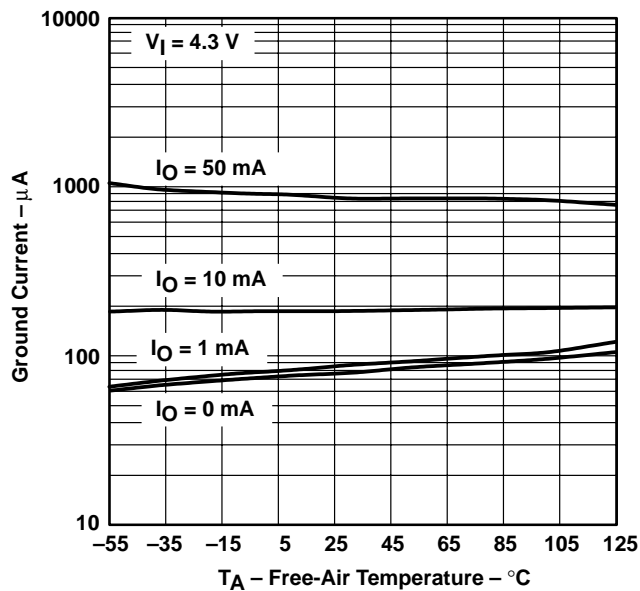
Figure 8

TEXAS
INSTRUMENTS
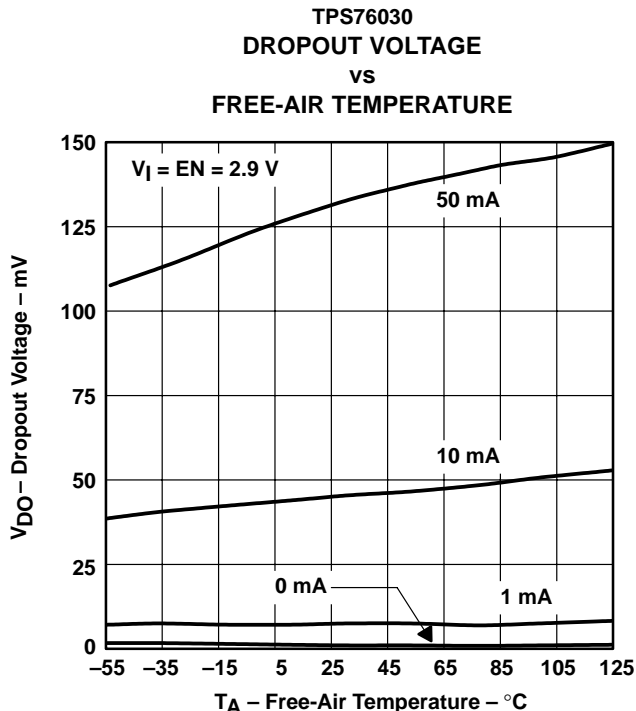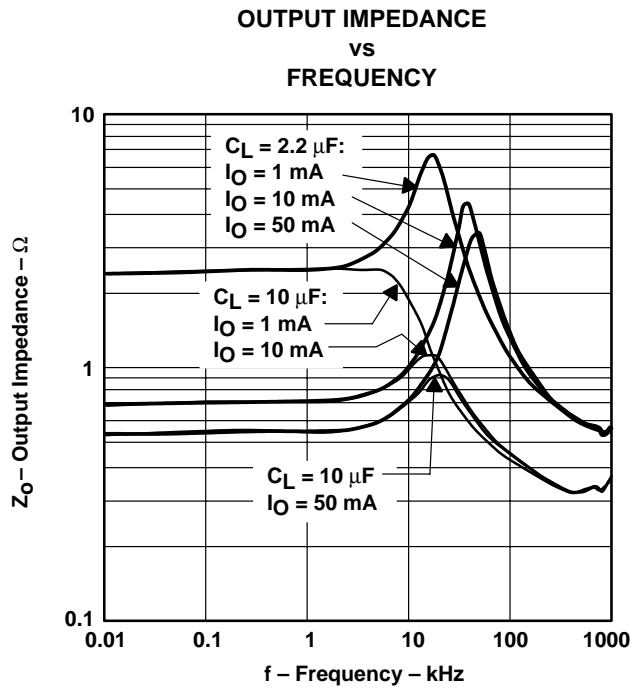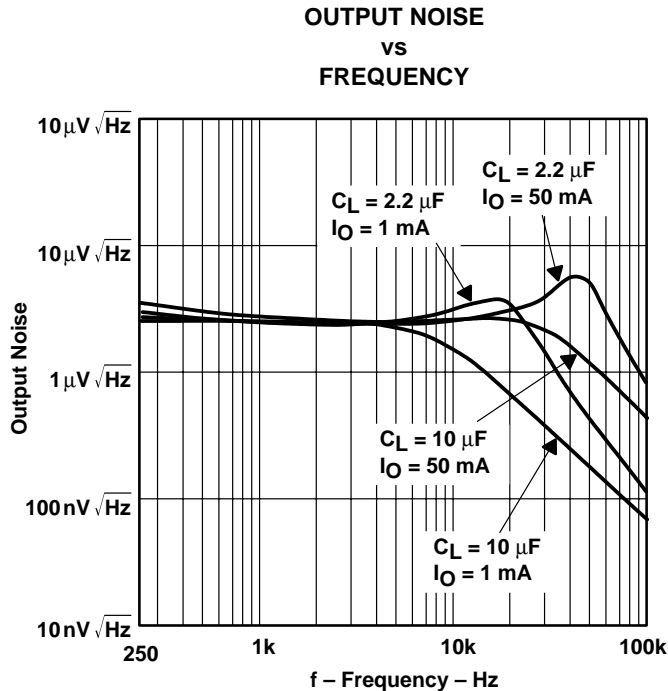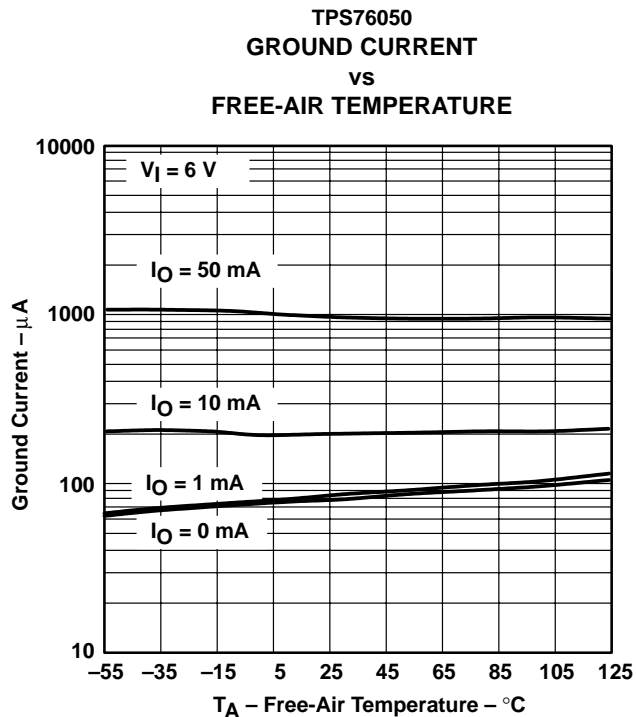
POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265

TYPICAL CHARACTERISTICS

TPS76050
GROUND CURRENT
vs
FREE-AIR TEMPERATURE

Figure 9

OUTPUT NOISE
vs
FREQUENCY

Figure 10

OUTPUT IMPEDANCE
vs
FREQUENCY

Figure 11

TPS76030
DROPOUT VOLTAGE
vs
FREE-AIR TEMPERATURE

Figure 12

TYPICAL CHARACTERISTICS

TPS76033
LINE TRANSIENT RESPONSE
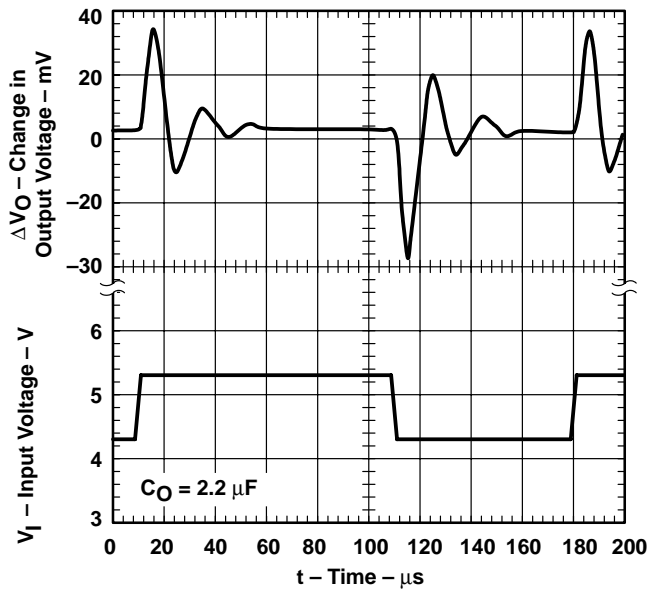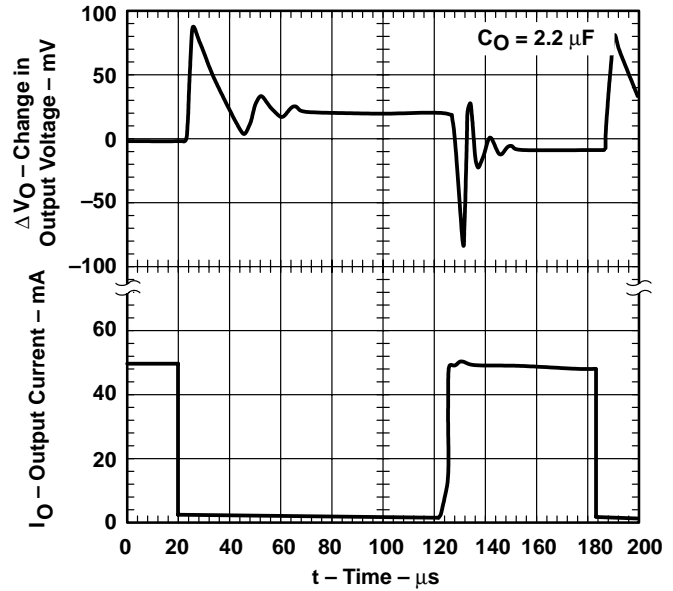
Figure 13

TPS76033
LOAD TRANSIENT RESPONSE

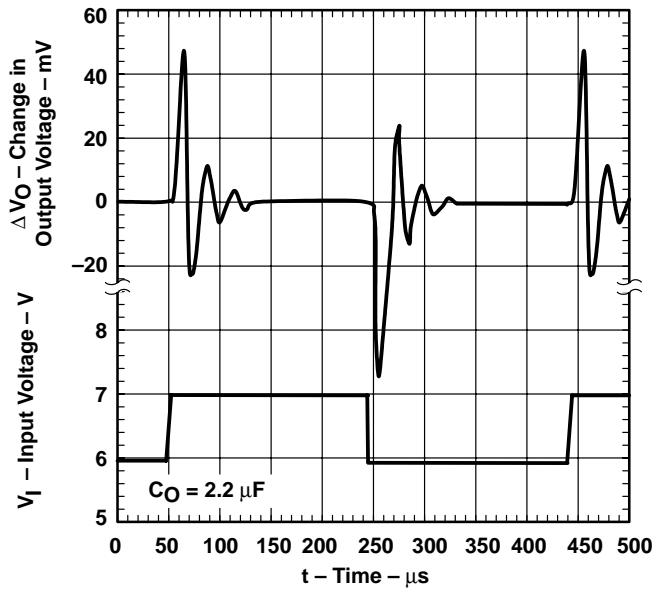Figure 14

TPS76050
LINE TRANSIENT RESPONSE
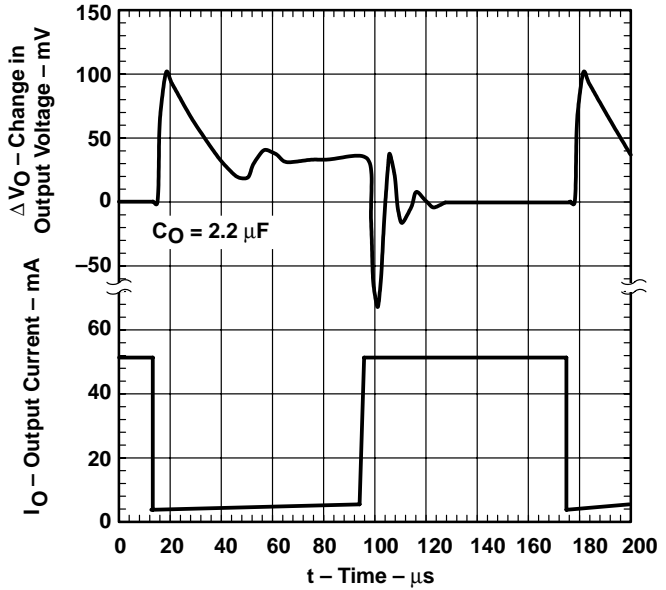
Figure 15

TPS76050
LOAD TRANSIENT RESPONSE

Figure 16
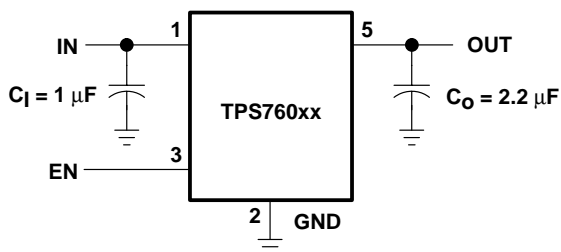
APPLICATION INFORMATION

Figure 17. TPS760xx Typical Application

over current protection

The over current protection circuit forces the TPS760xx into a constant current output mode when the load is excessive or the output is shorted to ground. Normal operation resumes when the fault condition is removed. An overload or short circuit may also activate the over temperature protection if the fault condition persists.

over temperature protection

The thermal protection system shuts the TPS760xx down when the junction temperature exceeds 160°C. The device recovers and operates normally when the temperature drops below 155°C.

input capacitor

A 0.047 μF or larger ceramic decoupling capacitor with short leads connected between IN and GND is recommended. The decoupling capacitor may be omitted if there is a 1 μF or larger electrolytic capacitor connected between IN and GND and located reasonably close to the TPS760xx. However, the small ceramic device is desirable even when the larger capacitor is present, if there is a lot of high frequency noise present in the system.

output capacitor

Like all low dropout regulators, the TPS760xx requires an output capacitor connected between OUT and GND to stabilize the internal control loop. The minimum recommended capacitance value is 2.2 μF and the ESR (equivalent series resistance) must be between 0.1 Ω and 20 Ω. Capacitor values of 2.5-μF or larger are acceptable, provided the ESR is less than 20 Ω. Solid tantalum electrolytic, aluminum electrolytic, and multilayer ceramic capacitors are all suitable, provided they meet the requirements described above. Most of the commercially available 2.2-μF surface-mount solid-tantalum capacitors, including devices from Sprague, Kemet, and Nichicon, meet the ESR requirements stated above. Multilayer ceramic capacitors should have minimum values of 2.5 μF over the full operating temperature range of the equipment.

enable (EN)

A logic zero on the enable input shuts the TPS760xx off and reduces the supply current to less than 1 μA. Pulling the enable input high causes normal operation to resume. If the enable feature is not used, EN should be connected to IN to keep the regulator on all of the time. The EN input must not be left floating.

reverse current path

The power transistor used in the TPS760xx has an inherent diode connected between IN and OUT as shown in the functional block diagram. This diode conducts current from the OUT terminal to the IN terminal whenever IN is lower than OUT by a diode drop. This condition does not damage the TPS760xx, provided the current is limited to 100 mA.
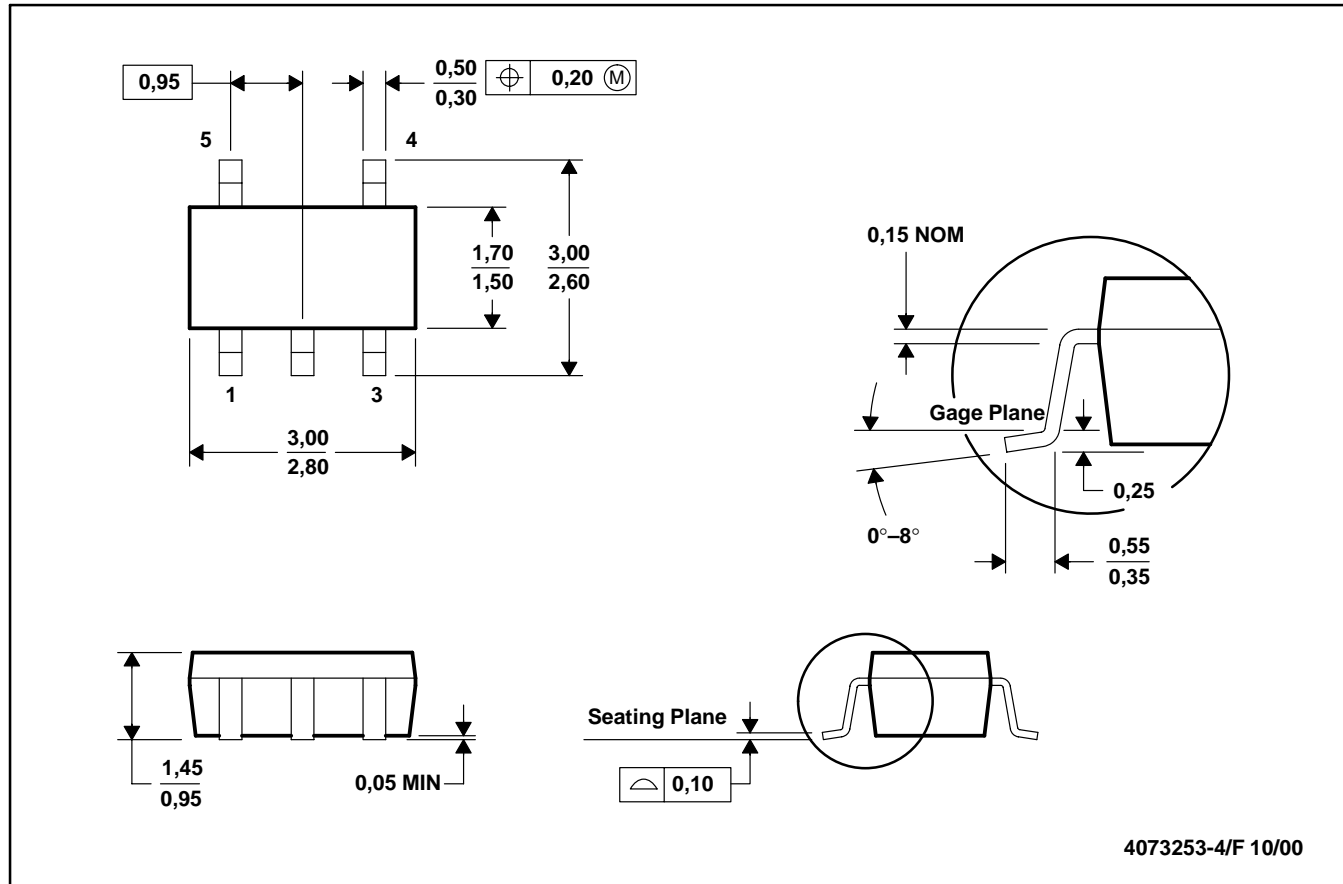
MECHANICAL DATA

DBV (R-PDSO-G5)   **PLASTIC SMALL-OUTLINE**

4073253-4/F 10/00

NOTES: A. All linear dimensions are in millimeters.
               B. This drawing is subject to change without notice.
               C. Body dimensions do not include mold flash or protrusion.
               D. Falls within JEDEC MO-178

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
TPS76030DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76030DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76030DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76030DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76032DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76032DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76032DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76032DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76033DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76033DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76033DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76033DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76038DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76038DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76038DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76038DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76050DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76050DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76050DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS76050DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check
http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION

REEL DIMENSIONS

Reel Diameter

Reel Width (W1)

TAPE DIMENSIONS

Cavity

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers
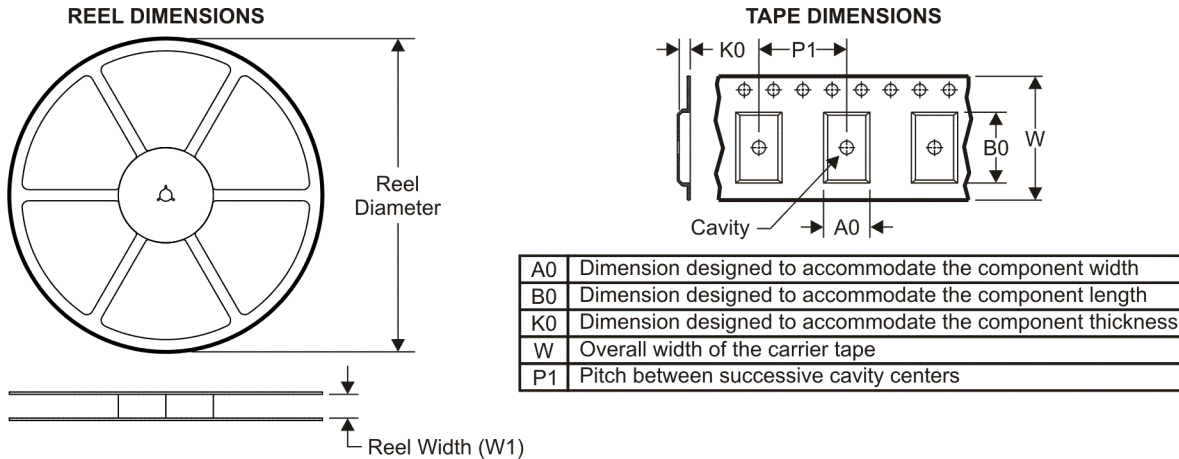
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

Sprocket Holes

User Direction of Feed

Pocket Quadrants

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS76030DBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76030DBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76032DBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76032DBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76033DBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76033DBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76038DBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76038DBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76050DBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76050DBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3

PACKAGE MATERIALS INFORMATION

11-Mar-2008

TAPE AND REEL BOX DIMENSIONS
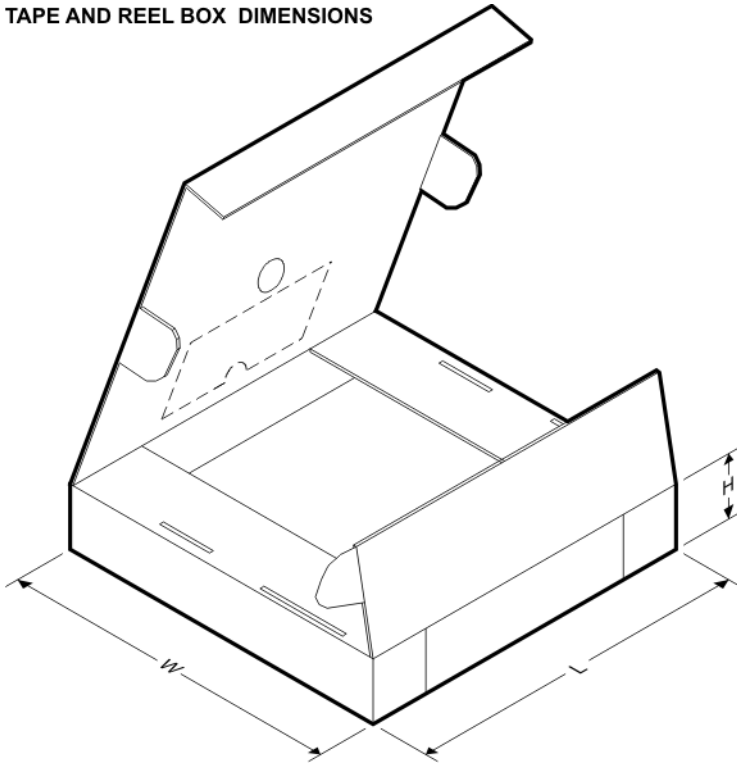
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS76030DBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS76030DBVT	SOT-23	DBV	5	250	182.0	182.0	20.0
TPS76032DBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS76032DBVT	SOT-23	DBV	5	250	182.0	182.0	20.0
TPS76033DBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS76033DBVT	SOT-23	DBV	5	250	182.0	182.0	20.0
TPS76038DBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS76038DBVT	SOT-23	DBV	5	250	182.0	182.0	20.0
TPS76050DBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS76050DBVT	SOT-23	DBV	5	250	182.0	182.0	20.0

DBV (R−PDSO−G5)   PLASTIC SMALL−OUTLINE PACKAGE
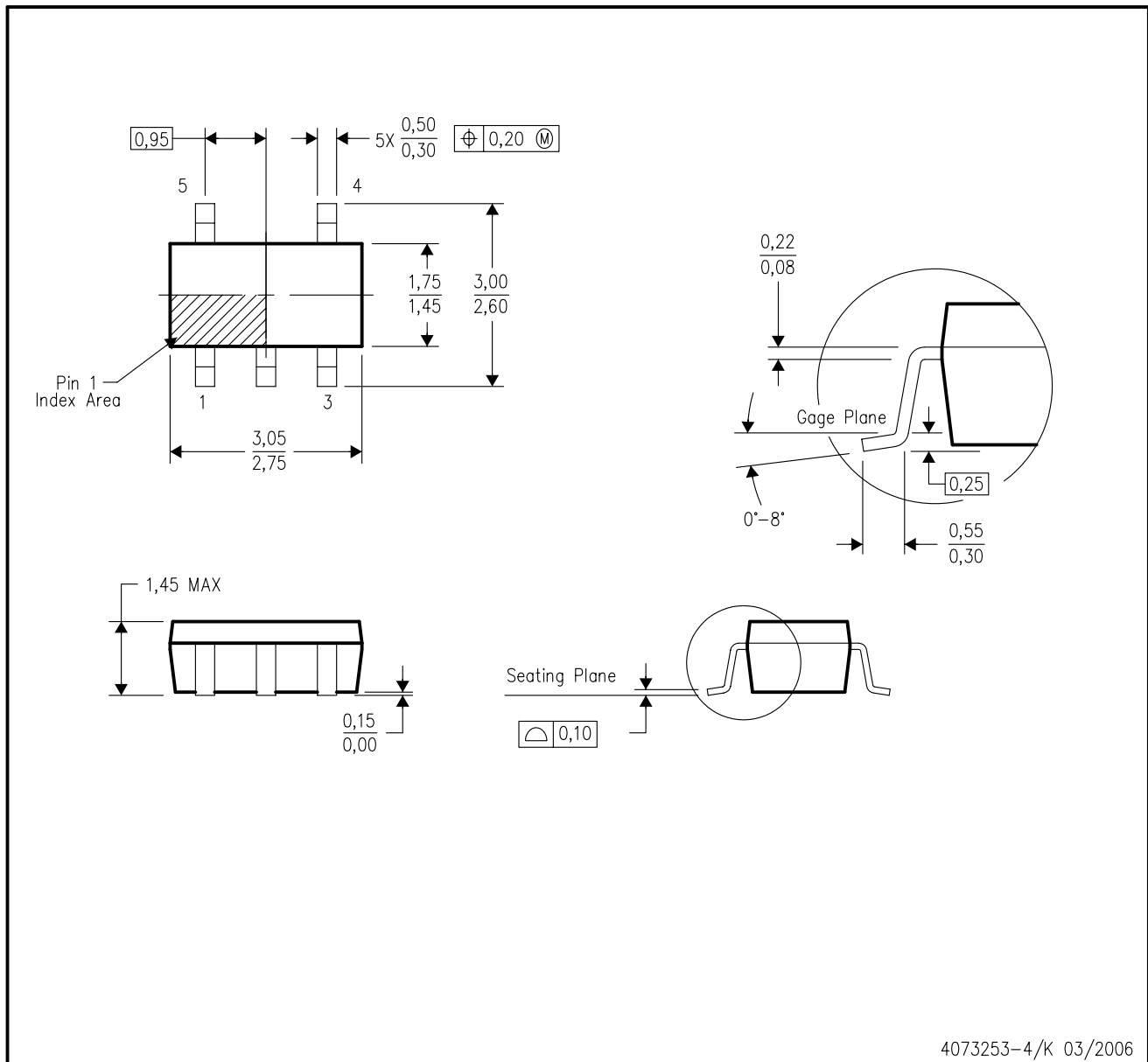
0,95

5X $\frac{0,50}{0,30}$ ⊕ |0,20 Ⓜ|

5   4

$\frac{1,75}{1,45}$ $\frac{3,00}{2,60}$

Pin 1
Index Area

1   3

$\frac{3,05}{2,75}$

$\frac{0,22}{0,08}$

Gage Plane

0°−8°

|0,25|

$\frac{0,55}{0,30}$

1,45 MAX

$\frac{0,15}{0,00}$

Seating Plane

|⌒|0,10|

4073253−4/K 03/2006

NOTES: A.   All linear dimensions are in millimeters.
         B.   This drawing is subject to change without notice.
         C.   Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
         D.   Falls within JEDEC MO−178 Variation AA.

IMPORTANT NOTICE

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		Wireless	www.ti.com/wireless